

Outline:

- 5.8 x 5.2mm Typ.(L x W),2.1mm Typ.Height
- Carrier tape packing, suitable for SMT process
- Low DCR and excellent current handling
- Magnetically shielded construction
- In addition to the standard versions of inductors shown here custom inductors are available to meet your exact requirements

Features:

- Core material:Ferrite
- Weight:0.22g
- Moisture Sensitivity:Level (MSL) 1
(unlimited floor life at 30°C /85% relative humidity).
- Operating temperature range: $-40^{\circ}\text{C}\sim+125^{\circ}\text{C}$
(including coil's self temperature rise)
- Storage temperature range: $-40^{\circ}\text{C}\sim+125^{\circ}\text{C}$

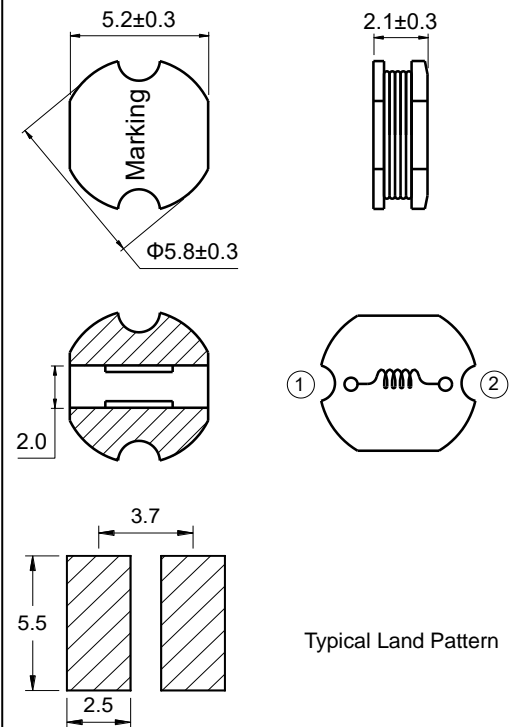
Application:

- Ideally used in Notebook PC,LCD T,Game machine STB
- buck converter,network communication equipment, and etc

1 Electrical Characteristics

Part No.	Inductance (μH) $\times 1$	D.C.R. (m Ω)		Isat	Irms
		Typical	Max	(A) $\times 2$	(A) $\times 3$
TG52-1R2M	1.20 $\pm 20\%$	15.0	13.4	5.50	4.90
TG52-2R2M	2.20 $\pm 20\%$	21.0	25.0	4.50	4.20
TG52-3R3M	3.30 $\pm 20\%$	32.8	35.8	3.90	3.43
TG52-4R7M	4.70 $\pm 20\%$	45.0	52.8	3.40	2.95
TG52-6R8M	6.80 $\pm 20\%$	62.0	76.8	2.75	2.54
TG52-100K	10.0 $\pm 10\%$	91	86.4	2.30	2.05
TG52-120K	12.0 $\pm 10\%$	115	114	2.00	1.82
TG52-150K	15.0 $\pm 10\%$	142	127	1.84	1.65
TG52-180K	18.0 $\pm 10\%$	171	154	1.62	1.50
TG52-220K	22.0 $\pm 10\%$	200	165	1.55	1.37
TG52-270K	27.0 $\pm 10\%$	234	223	1.40	1.26
TG52-330K	33.0 $\pm 10\%$	312	252	1.29	1.10
TG52-390K	39.0 $\pm 10\%$	342	316	1.08	1.04
TG52-470K	47.0 $\pm 10\%$	417	388	1.01	0.95
TG52-560K	56.0 $\pm 10\%$	525	420	0.96	0.85
TG52-680K	68.0 $\pm 10\%$	610	532	0.89	0.79
TG52-820K	82.0 $\pm 10\%$	810	677	0.78	0.68
TG52-101K	100 $\pm 10\%$	970	767	0.70	0.62
TG52-121K	120 $\pm 10\%$	1,105	1,128	0.68	0.58
TG52-151K	150 $\pm 10\%$	1,460	1,200	0.56	0.51
TG52-181K	180 $\pm 10\%$	1,650	1,392	0.54	0.48
TG52-221K	220 $\pm 10\%$	1,696	1,728	0.47	0.44
TG52-271K	270 $\pm 10\%$	2,370	1,932	0.44	0.40

2 Product Dimensions (mm)



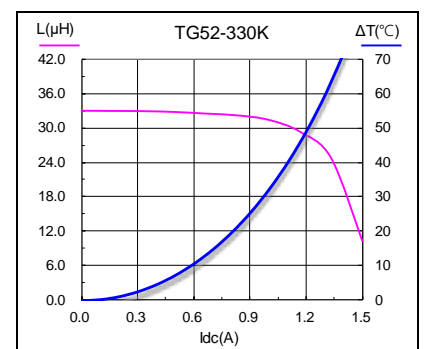
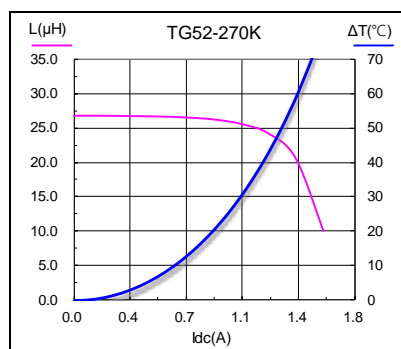
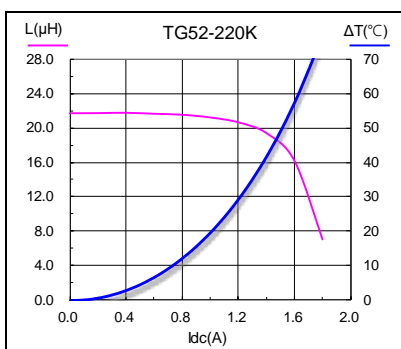
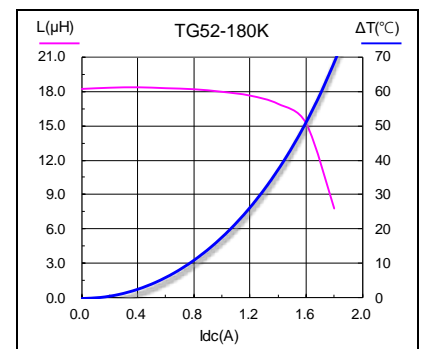
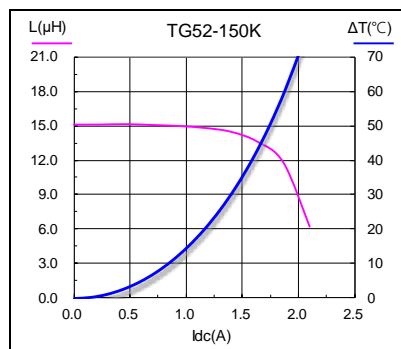
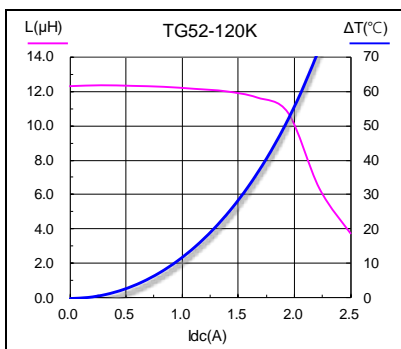
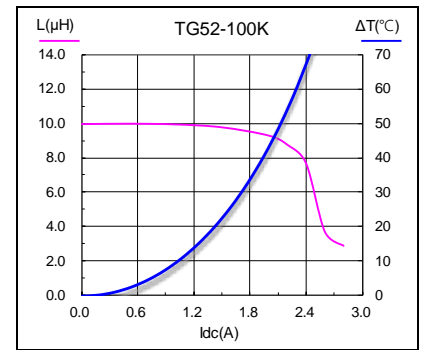
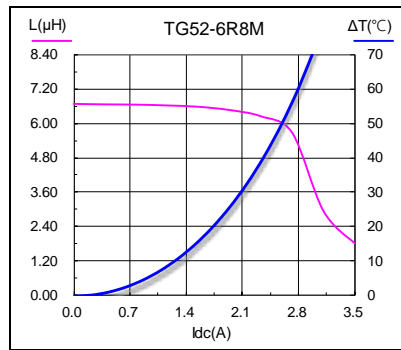
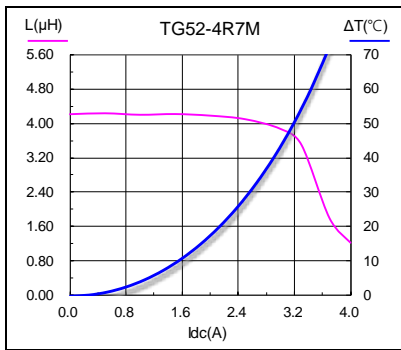
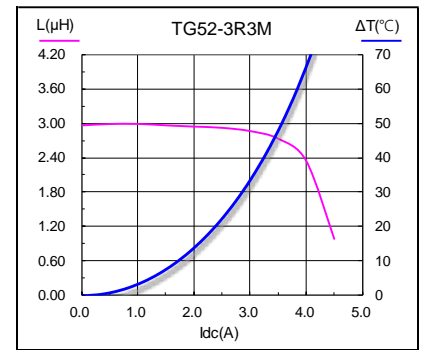
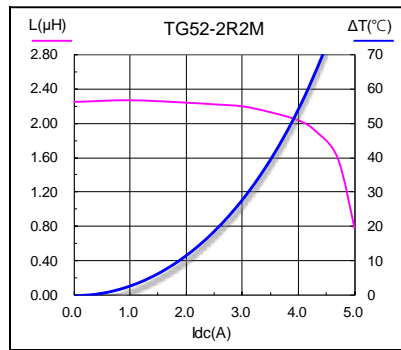
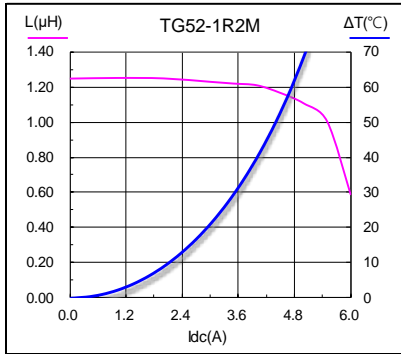
All data is tested on 25°C ambient temperature

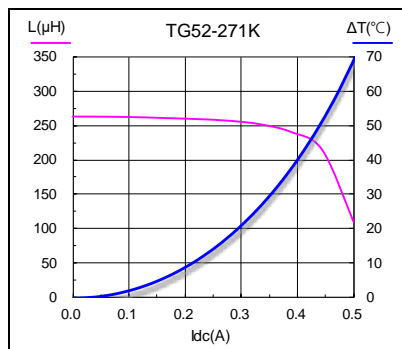
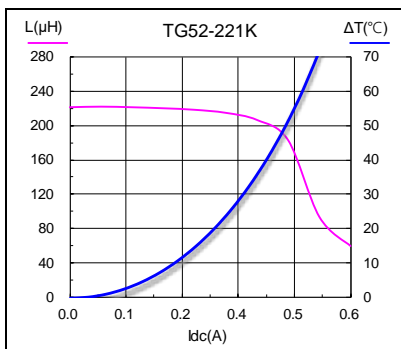
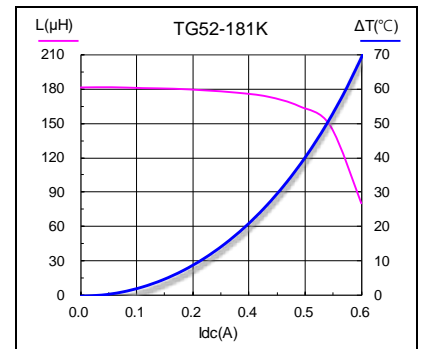
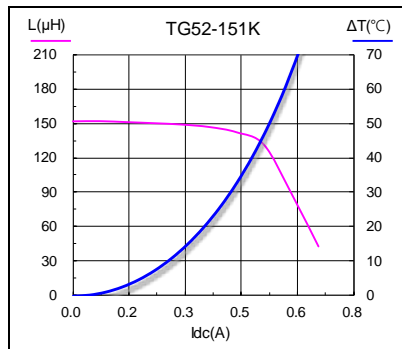
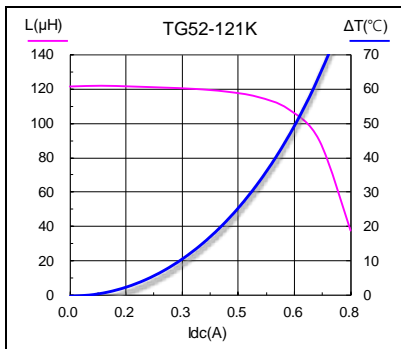
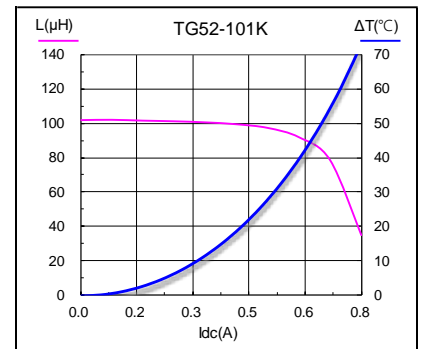
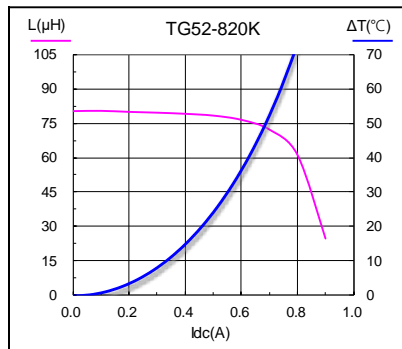
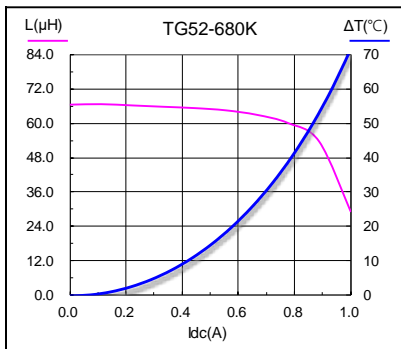
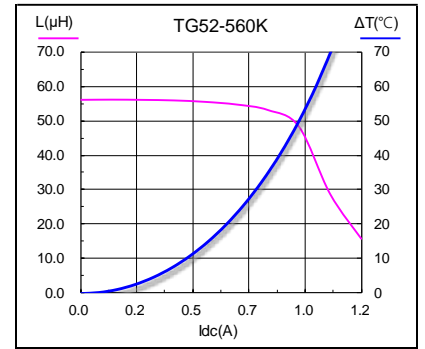
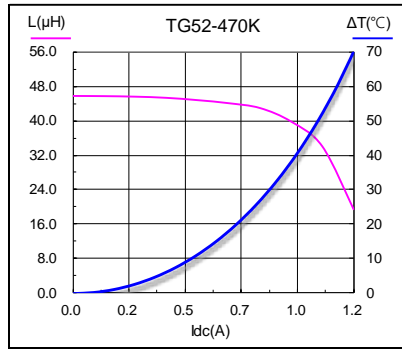
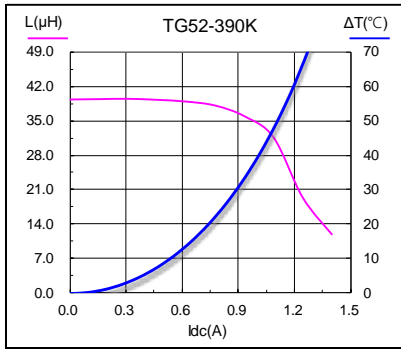
1. Inductance measure condition at 1.00kHz,0.25V

2. Isat:the actual value of DC current when the Inductance decrease 20% of its initial value

3. Irms:the actual value of DC current when the the temperature rise is $\Delta T40^{\circ}\text{C}$ ($T_a=25^{\circ}\text{C}$)

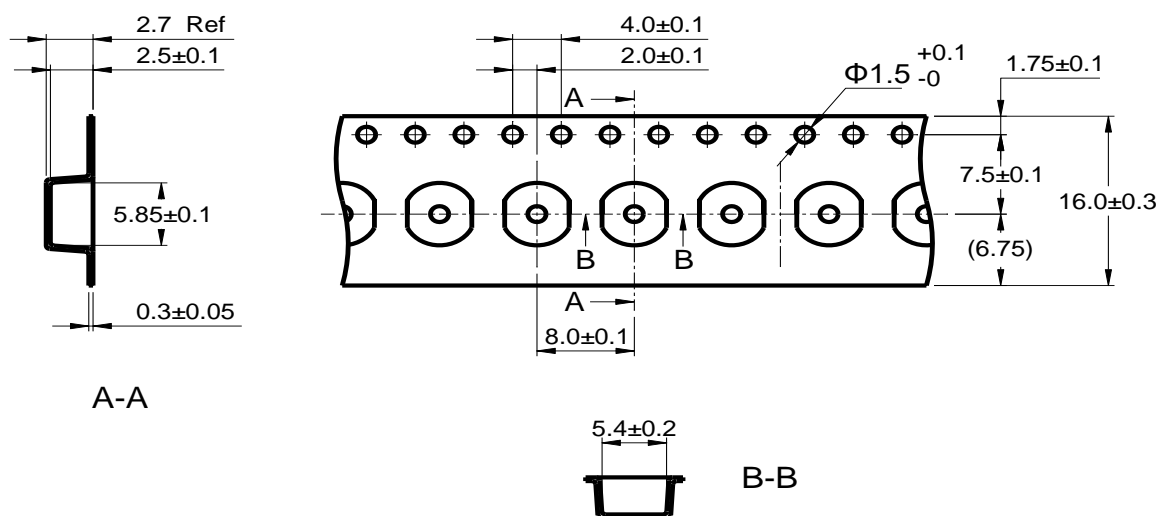
3 Saturation Current vs Temperature Rise Current Curve





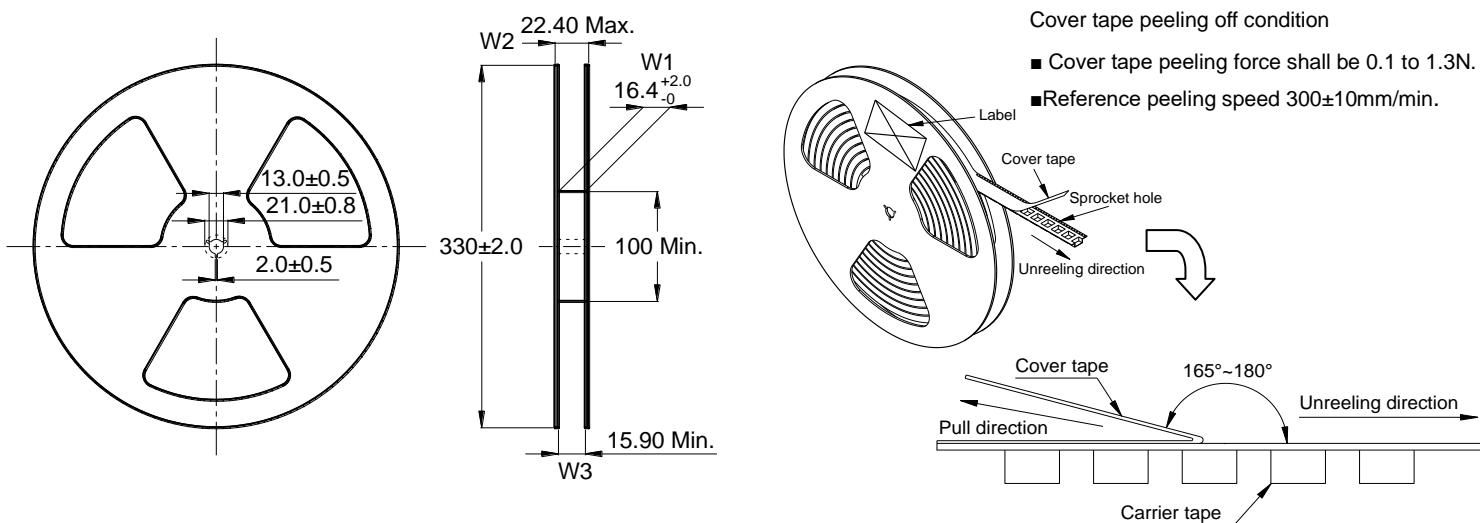
4 Packing Specification

4.1 Carrier Tape Dimensions (mm)



※ Packing is referred to the international standard IEC 60286-3.

4.2 Reel Dimensions (mm)



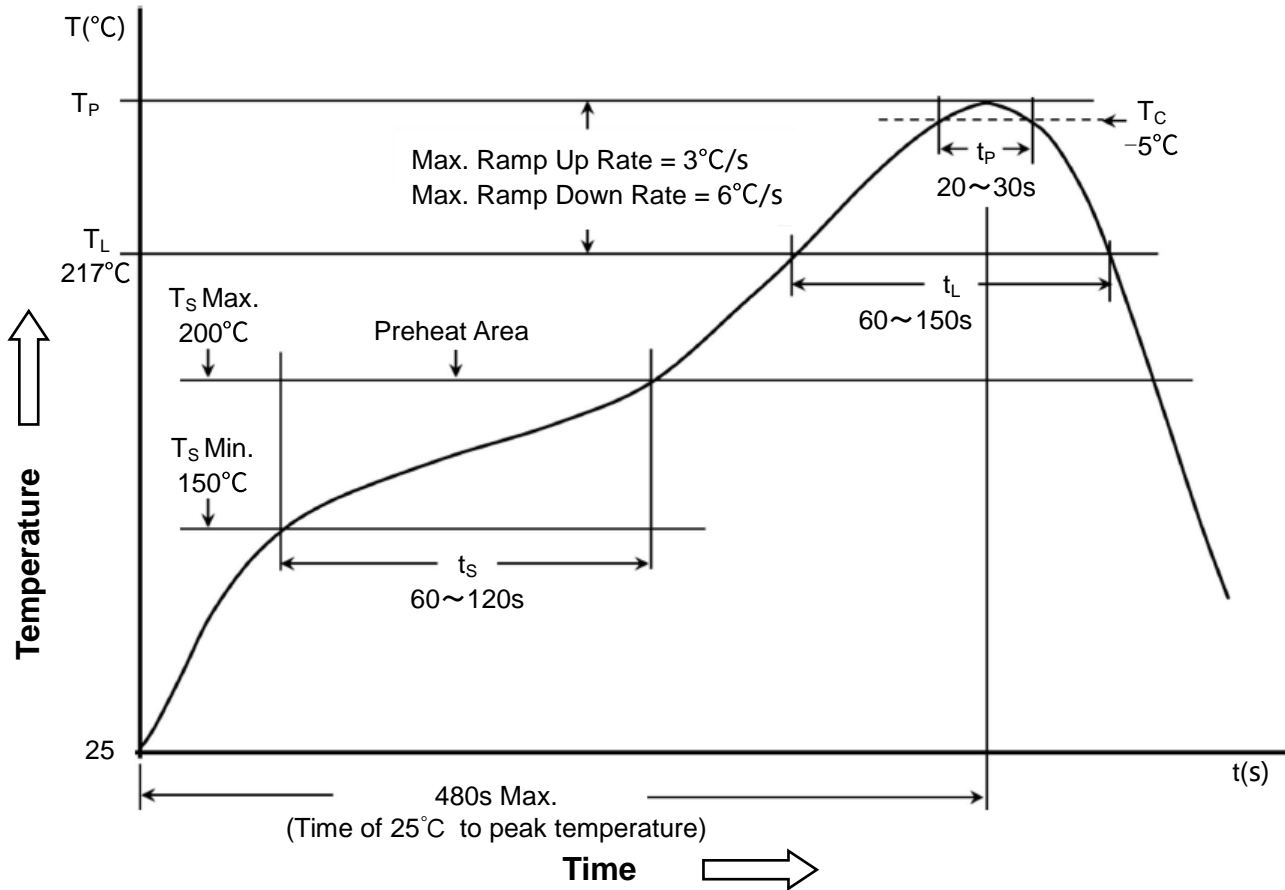
4.3 Carton Dimensions and Packing Quantity

- Inner Carton: 365×345×105mm
- Out Carton : 385×365×245mm

Product Series	Quantity / Reel	Inner Carton Quantity	Out Carton Quantity
TG52	3000pcs	(3000×4) = 12000pcs	(12000×2) = 24000pcs

5 Soldering Specification

5.1 Reflow Profile for SMT Components



5.2 Classification of Peak Package Body Temperature (Tp)

	Package Thickness	Package Volume		
		<350 mm ³	350~2000 mm ³	>2000 mm ³
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6~2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

※ Reflow is referred to standard IPC/JEDEC J-STD-020D.

6 Notice of Use

- 6.1 Special remind:Circuit design, component placement, PCB size and thickness, cooling system and etc. all will affect the product temperature. Please verify the product temperature in the final application.
- 6.2 Product in packing storage condition:temperature 5~40°C, RH≤70%.
If taking out for use, the remaining products should be sealed in plastic bags and preserved in accordance with the above conditions, to avoid oxidation of terminals (electrodes), affecting soldering status.
- 6.3 A storage of Codaca Electronic products for longer than 12 months is not recommended, Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.
- 6.4 Do not keep products in unsuitable storage conditions, such as areas susceptible to high temperatures, high humidity, dust or corrosion.
- 6.5 Always handle products with care.
- 6.6 Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering.
Always ensure optimum conditions for soldering.
- 6.7 When this product will be used on a similar or new project to the original one, sometimes it might be unable to satisfy the specifications due to different condition of usage.
- 6.8 This inductor itself does not have any protective function in abnormal condition, such as overload, short-circuit, open-circuit conditions, etc. Therefore, it shall be confirmed that there is no risk of smoke, fire, dielectric withstand voltage, insulation resistance, etc., or use in abnormal conditions protective devices or protection circuit in the end product.
- 6.9 Hi-Pot test with higher voltage than spec value will damage insulating material and shorten its life.
- 6.10 If using in potting compound, the magnet wire coating might be damaged, please consult with us.
- 6.11 Refrain from rinsing coils. If necessary, please consult with us.